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Quad (SD/HD) SDI Receiver with Adaptive Equalizer, VC-2 Decoder and Audio CODEC

TW6874

The TW6874 is a quad (SD/HD) SDI receiver. It has four independent channels, each consisting of an adaptive equalizer, clock data recovery, audio decoder and VC-2 decompression engine. Each channel receives high speed serial data over extended coaxial cable lengths and deserialize the data into video/audio streams for the back-end device.

The video streams are output as: 8-bit BT.656 for SD; BT.1120 in 8/16 bit mode for HD. The audio streams are output through an I2S audio digital interface in a multichannel interleaving format. In addition to the extraction of embedded SDI audio, the TW6874 incorporates a 5-channel audio ADC decoder to decode analog audio inputs and output them through the same I2S interface.

A visually lossless VC-2 (Dirac) compression/decompression engine is implemented in the TW6872/TW6874 SDI Tx/Rx pair to extend the reach of HD-SDI to that of SD-SDI. An interrupt pin can be used to signal the host processor of ancillary data packet detection. Finally, integrated audio test patterns and PRBS checker ease system design and implementation.

Applications

- SD/HD DVR

Features

- Quad (SD/HD) SDI receiver for standard (SD) and high (HD) definition 10-bit component video
- Automatic SDI detection of SMPTE 259M Level C (SD-SDI), SMPTE ST 292 (1.5G SDI) signals
- Each SDI input standard supported with ITU-R BT.656 (SD) or ITU-R BT.1120 (1.5G) interface
- Converts 10-bit serial digital component video input to 8-bit parallel video output
- Adaptive equalizer/clock data recovery/VC-2 decompression engine for each channel
- 4 separate video output ports with BT.656/BT.1120 output format
- 5-channel audio ADC (Analog-to-Digital Converter)
- Single multiplexed audio output DAC (Digital-to-Analog Converter)
- Supports I2S master/slave interface for record output and playback input with cascade
- I²C and SPI interface
- Pb-free (RoHS compliant) 256 ball LFBGA

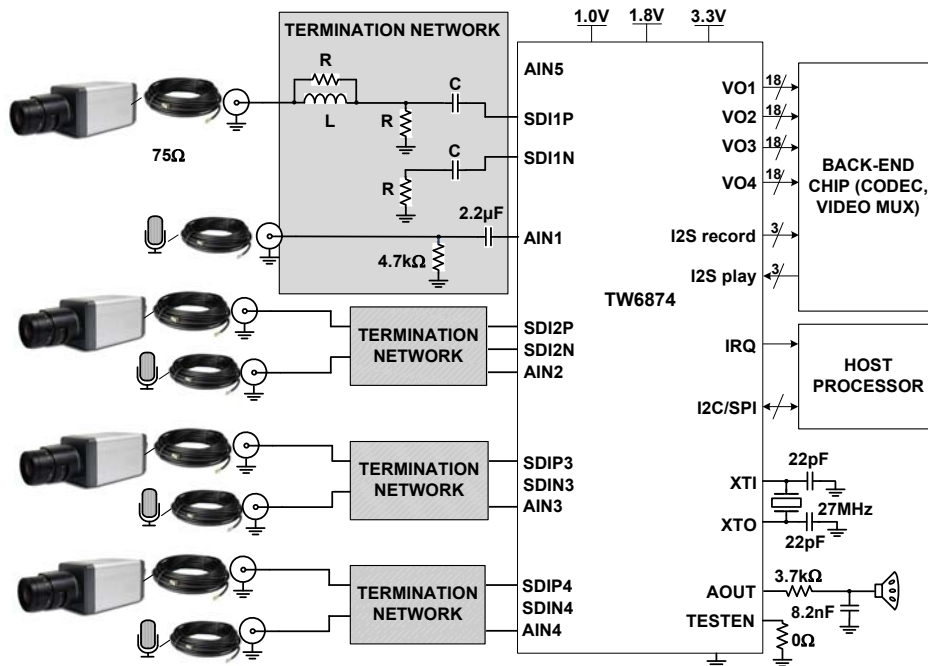


FIGURE 1. TW6874 TYPICAL APPLICATION

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Block Diagram

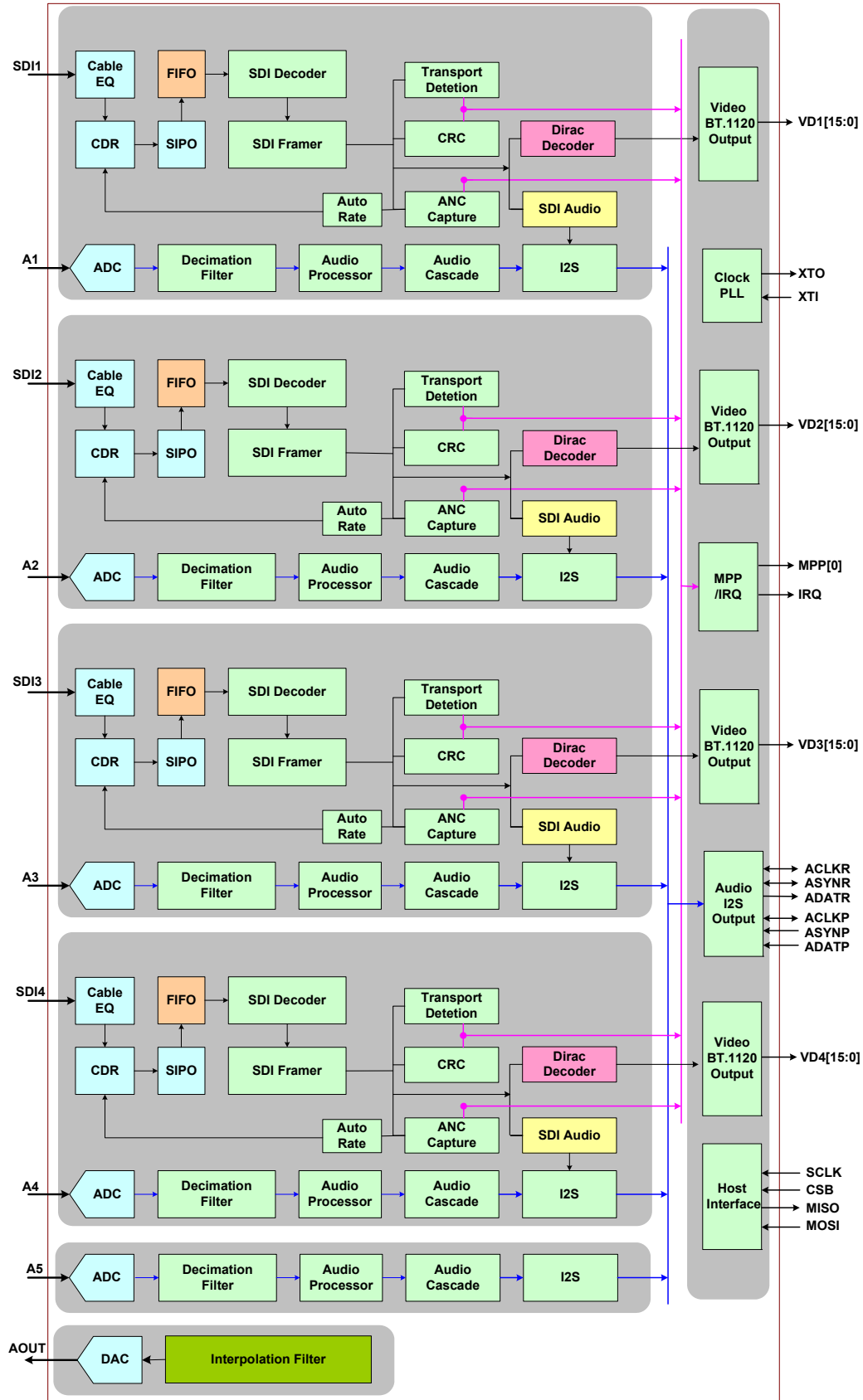


FIGURE 2. BLOCK DIAGRAM

TW6874

Pin Configuration

TW6874
(256 BALL 13.5mmx13.5mm LFBGA)
TOP VIEW

Analog Power

	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
A	AVSS_CDR1	AVDD_CDR1	AVSS_PLL18	DNC	DNC	DNC	XTO	AVDD_MISC18	AVDD_GUARD	SPIB	DNC	ASYNP	DNC	TESTEN	MOSI_SDA	ADATR
B	SDIP1	DNC	AVDD_PLL18	DNC	DNC	DNC	XTI	AVSS_MISC18	AVSS_GUARD	DNC	ALINK1	DNC	MISO_ADDR1	ACLKR	SCL	ALINK0
C	SDIN1	AVSS_EQ	AVDD_PLL10	AVSS_TST1	AVDD_TST1	AVSS_ESD	AVDD_XTAL	AVDD_MISC10	DNC	ADATP	ACLKP	DNC	RSTB	DNC	VD1_14	VD1_12
D	AVDD_REG1	AVSS_REG1	AVSS_PLL10	AVSS_EQ	AVSS_ESD	AVSS_ESD	AVSS_XTAL	AVSS_MISC10	DNC	MPP0	CSB_ADDR0	IRQ	ASYNR	VD1_13	VD1_10	VD1_8
E	AVDD_REG2	AVSS_REG2	AVSS_EQ	AVSS_EQ	AVSS_ESD	AVSS_ESD	DVDE	DVDE	DVDE	DVDE	DVDE	DVDDI	VD1_15	VD1_11	CLKN1	CLKP1
F	SDIN2	AVSS_EQ	AVSS_EQ	AVSS_EQ	AVSS_ESD	DVDE	DVDE	DVSS	DVSS	DVSS	DVSS	DVDDI	VD1_9	VD1_7	VD1_6	VD1_4
G	SDIP2	DNC	AVSS_EQ	AVSS_ESD	AVSS_ESD	DVDE	DVDE	DVSS	DVSS	DVSS	DVSS	DVDDI	VD1_5	VD1_3	VD1_2	VD1_1
H	AVDD_CDR2	AVSS_CDR2	AVDD_BG	AVSS_ESD	AVSS_ESD	AVSS_ESD	DVSS	DVSS	DVSS	DVSS	DVSS	DVDDI	VD1_0	VD2_14	VD2_13	VD2_15
J	AVDD_CDR3	AVSS_CDR3	AVSS_BG	AVSS_ESD	AVSS_ESD	AVSS_ESD	DVSS	DVSS	DVSS	DVSS	DVSS	DVDE	VD2_10	VD2_8	VD2_12	VD2_11
K	SDIP3	DNC	AVSS_EQ	AVSS_EQ	AVSS_ESD	AVSS_ESD	DVDDI	DVSS	DVSS	DVSS	DVSS	DVDE	VD2_4	VD2_6	VD2_9	CLKN2
L	SDIN3	AVSS_EQ	AVSS_EQ	AVSS_EQ	AVSS_ESD	DVDDI	DVDDI	DVSS	DVSS	DVSS	DVSS	DVDE	VD2_1	VD2_3	VD2_7	CLKP2
M	AVDD_REG3	AVSS_REG3	AVSS_EQ	AVSS_EQ	AVSS_ESD	DVDDI	DVDDI	DVDDI	DVDDI	DVDDI	DVDDI	DVDE	VD3_13	VD3_15	VD2_2	VD2_5
N	AVDD_REG4	AVSS_REG4	AVSS_TST4	AVSS_DAC	AOUT	AIN1	AVSS_FPLL18	ADCREP	VD4_5	VD4_8	VD4_12	VD3_2	VD3_9	VD3_11	VD3_12	VD2_0
P	SDIN4	AVSS_EQ	AVDD_TST4	AVDD_DAC	AIN2	AIN5	AVDD_FPLL18	VD4_1	VD4_3	VD4_7	VD4_10	VD4_14	VD3_0	VD3_7	VD3_10	VD3_14
R	SDIP4	DNC	DNC	DNC	AIN3	AVSS_AFE	AVSS_FPLL10	VD4_0	VD4_4	CLKN4	VD4_11	VD4_15	VD3_3	VD3_4	CLKN3	CLKP3
T	AVSS_CDR4	AVDD_CDR4	DNC	DNC	AIN4	AVDD_AFE	AVDD_FPLL10	VD4_2	VD4_6	CLKP4	VD4_9	VD4_13	VD3_1	VD3_5	VD3_6	VD3_8

- : Analog 1.0V
- : Analog 1.8V
- : Analog ground
- : VDD/VSS pair




TW6874

Pin Configuration (Continued)

TW6874
(256 BALL 13.5mmx13.5mm LFBGA)
TOP VIEW

Digital Power

	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
A	AVSS_CDR1	AVDD_CDR1	AVSS_PLL18	DNC	DNC	DNC	XTO	AVDD_MISC1 ₈	AVDD_GUAR _D	SPIB	DNC	ASYNP	DNC	TESTEN	MOSI_SDA	ADATR
B	SDIP1	DNC	AVDD_PLL18	DNC	DNC	DNC	XTI	AVSS_MISC1 ₈	AVSS_GUAR _D	DNC	ALINK1	DNC	MISO_ADDR1	ACLKR	SCL	ALINK0
C	SDIN1	AVSS_EQ	AVDD_PLL10	AVSS_TST1	AVDD_TST1	AVSS_ESD	AVDD_XTAL	AVDD_MISC1 ₀	DNC	ADATP	ACLKP	DNC	RSTB	DNC	VD1_14	VD1_12
D	AVDD_REG1	AVSS_REG1	AVSS_PLL10	AVSS_EQ	AVSS_ESD	AVSS_ESD	AVSS_XTAL	AVSS_MISC1 ₀	DNC	MPP0	CSB_ADDR0	IRQ	ASYNR	VD1_13	VD1_10	VD1_8
E	AVDD_REG2	AVSS_REG2	AVSS_EQ	AVSS_EQ	AVSS_ESD	AVSS_ESD	DVDDDE	DVDDDE	DVDDDE	DVDDDE	DVDDDE	DVDDI	VD1_15	VD1_11	CLKN1	CLKP1
F	SDIN2	AVSS_EQ	AVSS_EQ	AVSS_EQ	AVSS_ESD	DVDDDE	DVDDDE	DVSS	DVSS	DVSS	DVSS	DVDDI	VD1_9	VD1_7	VD1_6	VD1_4
G	SDIP2	DNC	AVSS_EQ	AVSS_ESD	AVSS_ESD	DVDDDE	DVDDDE	DVSS	DVSS	DVSS	DVSS	DVDDI	VD1_5	VD1_3	VD1_2	VD1_1
H	AVDD_CDR2	AVSS_CDR2	AVDD_BG	AVSS_ESD	AVSS_ESD	AVSS_ESD	DVSS	DVSS	DVSS	DVSS	DVSS	DVDDI	VD1_0	VD2_14	VD2_13	VD2_15
J	AVDD_CDR3	AVSS_CDR3	AVSS_BG	AVSS_ESD	AVSS_ESD	AVSS_ESD	DVSS	DVSS	DVSS	DVSS	DVSS	DVDDDE	VD2_10	VD2_8	VD2_12	VD2_11
K	SDIP3	DNC	AVSS_EQ	AVSS_EQ	AVSS_ESD	AVSS_ESD	DVDDI	DVSS	DVSS	DVSS	DVSS	DVDDDE	VD2_4	VD2_6	VD2_9	CLKN2
L	SDIN3	AVSS_EQ	AVSS_EQ	AVSS_EQ	AVSS_ESD	DVDDI	DVDDI	DVSS	DVSS	DVSS	DVSS	DVDDDE	VD2_1	VD2_3	VD2_7	CLKP2
M	AVDD_REG3	AVSS_REG3	AVSS_EQ	AVSS_EQ	AVSS_ESD	DVDDI	DVDDI	DVDDI	DVDDI	DVDDI	DVDDI	DVDDDE	VD3_13	VD3_15	VD2_2	VD2_5
N	AVDD_REG4	AVSS_REG4	AVSS_TST4	AVSS_DAC	AOUT	AIN1	AVSS_FPLL18	ADCREP	VD4_5	VD4_8	VD4_12	VD3_2	VD3_9	VD3_11	VD3_12	VD2_0
P	SDIN4	AVSS_EQ	AVDD_TST4	AVDD_DAC	AIN2	AIN5	AVDD_FPLL1 ₈	VD4_1	VD4_3	VD4_7	VD4_10	VD4_14	VD3_0	VD3_7	VD3_10	VD3_14
R	SDIP4	DNC	DNC	DNC	AIN3	AVSS_AFE	AVSS_FPLL10	VD4_0	VD4_4	CLKN4	VD4_11	VD4_15	VD3_3	VD3_4	CLKN3	CLKP3
T	AVSS_CDR4	AVDD_CDR4	DNC	DNC	AIN4	AVDD_AFE	AVDD_FPLL1 ₀	VD4_2	VD4_6	CLKP4	VD4_9	VD4_13	VD3_1	VD3_5	VD3_6	VD3_8

	: Digital 1.0V
	: Digital 3.3V
	: Digital ground

TW6874

Pin Configuration (Continued)

TW6874
(256 BALL 13.5mmx13.5mm LFBGA)
TOP VIEW

Signals

	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
A	AVSS_CDR1	AVDD_CDR1	AVSS_PLL18	DNC	DNC	DNC	XT0	AVDD_MISC1 ₈	AVDD_GUAR _D	SPIB	DNC	ASYNP	DNC	TESTEN	MOSI_SDA	ADATR
B	SDIP1	DNC	AVDD_PLL18	DNC	DNC	DNC	XT1	AVSS_MISC1 ₈	AVSS_GUAR _D	DNC	ALINK1	DNC	MISO_ADDR1	ACLKR	SCL	ALINK0
C	SDIN1	AVSS_EQ	AVDD_PLL10	AVSS_TST1	AVDD_TST1	AVSS_ESD	AVDD_XTAL	AVDD_MISC1 ₀	DNC	ADATP	ACLKP	DNC	RSTB	DNC	VD1_14	VD1_12
D	AVDD_REG1	AVSS_REG1	AVSS_PLL10	AVSS_EQ	AVSS_ESD	AVSS_ESD	AVSS_XTAL	AVSS_MISC1 ₀	DNC	MPP0	CSB_ADDR0	IRQ	ASYNR	VD1_13	VD1_10	VD1_8
E	AVDD_REG2	AVSS_REG2	AVSS_EQ	AVSS_EQ	AVSS_ESD	AVSS_ESD	DVDE	DVDE	DVDE	DVDE	DVDE	DVDDI	VD1_15	VD1_11	CLKN1	CLKP1
F	SDIN2	AVSS_EQ	AVSS_EQ	AVSS_EQ	AVSS_ESD	DVDE	DVDE	DVSS	DVSS	DVSS	DVSS	DVDDI	VD1_9	VD1_7	VD1_6	VD1_4
G	SDIP2	DNC	AVSS_EQ	AVSS_ESD	AVSS_ESD	DVDE	DVDE	DVSS	DVSS	DVSS	DVSS	DVDDI	VD1_5	VD1_3	VD1_2	VD1_1
H	AVDD_CDR2	AVSS_CDR2	AVDD_BG	AVSS_ESD	AVSS_ESD	AVSS_ESD	DVSS	DVSS	DVSS	DVSS	DVSS	DVDDI	VD1_0	VD2_14	VD2_13	VD2_15
J	AVDD_CDR3	AVSS_CDR3	AVSS_BG	AVSS_ESD	AVSS_ESD	AVSS_ESD	DVSS	DVSS	DVSS	DVSS	DVSS	DVDE	VD2_10	VD2_8	VD2_12	VD2_11
K	SDIP3	DNC	AVSS_EQ	AVSS_EQ	AVSS_ESD	AVSS_ESD	DVDDI	DVSS	DVSS	DVSS	DVSS	DVDE	VD2_4	VD2_6	VD2_9	CLKN2
L	SDIN3	AVSS_EQ	AVSS_EQ	AVSS_EQ	AVSS_ESD	DVDDI	DVDDI	DVSS	DVSS	DVSS	DVSS	DVDE	VD2_1	VD2_3	VD2_7	CLKP2
M	AVDD_REG3	AVSS_REG3	AVSS_EQ	AVSS_EQ	AVSS_ESD	DVDDI	DVDDI	DVDDI	DVDDI	DVDDI	DVDDI	DVDE	VD3_13	VD3_15	VD2_2	VD2_5
N	AVDD_REG4	AVSS_REG4	AVSS_TST4	AVSS_DAC	AOUT	AIN1	AVSS_FPLL18	ADCREG	VD4_5	VD4_8	VD4_12	VD3_2	VD3_9	VD3_11	VD3_12	VD2_0
P	SDIN4	AVSS_EQ	AVDD_TST4	AVDD_DAC	AIN2	AIN5	AVDD_FPLL1 ₈	VD4_1	VD4_3	VD4_7	VD4_10	VD4_14	VD3_0	VD3_7	VD3_10	VD3_14
R	SDIP4	DNC	DNC	DNC	AIN3	AVSS_AFE	AVSS_FPLL10	VD4_0	VD4_4	CLKN4	VD4_11	VD4_15	VD3_3	VD3_4	CLKN3	CLKP3
T	AVSS_CDR4	AVDD_CDR4	DNC	DNC	AIN4	AVDD_AFE	AVDD_FPLL1 ₀	VD4_2	VD4_6	CLKP4	VD4_9	VD4_13	VD3_1	VD3_5	VD3_6	VD3_8

■ : Analog SDI input signals
■ : Analog audio I/O signals
■ : X-tal I/O pins
■ : DNC & Misc pins

■ : CH1 digital output port
■ : CH2 digital output port
■ : CH3 digital output port
■ : CH4 digital output port

Pin Descriptions

PIN LOCATION	PIN NAME	TYPE	DESCRIPTION
B1	SDIP1	Analog Input	SDI input for channel 1. Terminate with 75Ω to ground and AC-couple with 1μF.
C1	SDIN1	Analog Input	Inverting SDI input for channel 1. Terminate with 37.4Ω to ground and AC-couple with 1μF. Do not connect the external SDI signal to this pin.
G1	SDIP2	Analog Input	SDI input for channel 2. Terminate with 75Ω to ground and AC-couple with 1μF.
F1	SDIN2	Analog Input	Inverting SDI input for channel 2. Terminate with 37.4Ω to ground and AC-couple with 1μF. Do not connect the external SDI signal to this pin.
K1	SDIP3	Analog Input	SDI input for channel 3. Terminate with 75Ω to ground and AC-couple with 1μF.
L1	SDIN3	Analog Input	Inverting SDI input for channel 3. Terminate with 37.4Ω to ground and AC-couple with 1μF. Do not connect the external SDI signal to this pin.
R1	SDIP4	Analog Input	SDI input for channel 4. Terminate with 75Ω to ground and AC-couple with 1μF.
P1	SDIN4	Analog Input	Inverting SDI input for channel 4. Terminate with 37.4Ω to ground and AC-couple with 1μF. Do not connect the external SDI signal to this pin.
N6	AIN1	Analog Input	Audio input for channel 1. Terminate with 4.7kΩ to ground and AC-couple with 2.2μF.
P5	AIN2	Analog Input	Audio input for channel 2. Terminate with 4.7kΩ to ground and AC-couple with 2.2μF.
R5	AIN3	Analog Input	Audio input for channel 3. Terminate with 4.7kΩ to ground and AC-couple with 2.2μF.
T5	AIN4	Analog Input	Audio input for channel 4. Terminate with 4.7kΩ to ground and AC-couple with 2.2μF.
P6	AIN5	Analog Input	Audio input for channel 5. Terminate with 4.7kΩ to ground and AC-couple with 2.2μF.
N8	ADCREP	Analog Input	Audio ADC reference. Terminate with 2.2μF to ground. Do not connect external audio signal to this pin.
N5	AOUT	Analog Output	Analog audio output.
H13	VD1_0	Digital Output	Video data output for channel 1.
G16	VD1_1	Digital Output	Video data output for channel 1.
G15	VD1_2	Digital Output	Video data output for channel 1.
G14	VD1_3	Digital Output	Video data output for channel 1.
F16	VD1_4	Digital Output	Video data output for channel 1.
G13	VD1_5	Digital Output	Video data output for channel 1.
F15	VD1_6	Digital Output	Video data output for channel 1.
F14	VD1_7	Digital Output	Video data output for channel 1.
D16	VD1_8	Digital Output	Video data output for channel 1.
F13	VD1_9	Digital Output	Video data output for channel 1.
D15	VD1_10	Digital Output	Video data output for channel 1.
E14	VD1_11	Digital Output	Video data output for channel 1.
C16	VD1_12	Digital Output	Video data output for channel 1.
D14	VD1_13	Digital Output	Video data output for channel 1.
C15	VD1_14	Digital Output	Video data output for channel 1.
E13	VD1_15	Digital Output	Video data output for channel 1.
E16	CLKP1	Digital Output	Reserved
E15	CLKN1	Digital Output	Clock for VD1.
N16	VD2_0	Digital Output	Video data output for channel 2.

Pin Descriptions (Continued)

PIN LOCATION	PIN NAME	TYPE	DESCRIPTION
L13	VD2_1	Digital Output	Video data output for channel 2.
M15	VD2_2	Digital Output	Video data output for channel 2.
L14	VD2_3	Digital Output	Video data output for channel 2.
K13	VD2_4	Digital Output	Video data output for channel 2.
M16	VD2_5	Digital Output	Video data output for channel 2.
K14	VD2_6	Digital Output	Video data output for channel 2.
L15	VD2_7	Digital Output	Video data output for channel 2.
J14	VD2_8	Digital Output	Video data output for channel 2.
K15	VD2_9	Digital Output	Video data output for channel 2.
J13	VD2_10	Digital Output	Video data output for channel 2.
J16	VD2_11	Digital Output	Video data output for channel 2.
J15	VD2_12	Digital Output	Video data output for channel 2.
H15	VD2_13	Digital Output	Video data output for channel 2.
H14	VD2_14	Digital Output	Video data output for channel 2.
H16	VD2_15	Digital Output	Video data output for channel 2.
L16	CLKP2	Digital Output	Reserved
K16	CLKN2	Digital Output	Clock for VD2.
P13	VD3_0	Digital Output	Video data output for channel 3.
T13	VD3_1	Digital Output	Video data output for channel 3.
N12	VD3_2	Digital Output	Video data output for channel 3.
R13	VD3_3	Digital Output	Video data output for channel 3.
R14	VD3_4	Digital Output	Video data output for channel 3.
T14	VD3_5	Digital Output	Video data output for channel 3.
T15	VD3_6	Digital Output	Video data output for channel 3.
P14	VD3_7	Digital Output	Video data output for channel 3.
T16	VD3_8	Digital Output	Video data output for channel 3.
N13	VD3_9	Digital Output	Video data output for channel 3.
P15	VD3_10	Digital Output	Video data output for channel 3.
N14	VD3_11	Digital Output	Video data output for channel 3.
N15	VD3_12	Digital Output	Video data output for channel 3.
M13	VD3_13	Digital Output	Video data output for channel 3.
P16	VD3_14	Digital Output	Video data output for channel 3.
M14	VD3_15	Digital Output	Video data output for channel 3.
R16	CLKP3	Digital Output	Reserved
R15	CLKN3	Digital Output	Clock for VD3.
R8	VD4_0	Digital Output	Video data output for channel 4.
P8	VD4_1	Digital Output	Video data output for channel 4.
T8	VD4_2	Digital Output	Video data output for channel 4.
P9	VD4_3	Digital Output	Video data output for channel 4.
R9	VD4_4	Digital Output	Video data output for channel 4.
N9	VD4_5	Digital Output	Video data output for channel 4.

Pin Descriptions (Continued)

PIN LOCATION	PIN NAME	TYPE	DESCRIPTION
T9	VD4_6	Digital Output	Video data output for channel 4.
P10	VD4_7	Digital Output	Video data output for channel 4.
N10	VD4_8	Digital Output	Video data output for channel 4.
T11	VD4_9	Digital Output	Video data output for channel 4.
P11	VD4_10	Digital Output	Video data output for channel 4.
R11	VD4_11	Digital Output	Video data output for channel 4.
N11	VD4_12	Digital Output	Video data output for channel 4.
T12	VD4_13	Digital Output	Video data output for channel 4.
P12	VD4_14	Digital Output	Video data output for channel 4.
R12	VD4_15	Digital Output	Video data output for channel 4.
T10	CLKP4	Digital Output	Reserved
R10	CLKN4	Digital Output	Clock for VD4.
D12	IRQ	Digital Output	Interrupt request.
B11	ALINKI	Digital Input	Serial audio multidevice link input.
B16	ALINKO	Digital Output	Serial audio multidevice link output.
C11	ACLKP	Digital I/O	Serial audio playback clock input/output.
A12	ASYNP	Digital I/O	Serial audio playback sync input/output.
C10	ADATP	Digital Input	Serial audio playback data input.
B14	ACLKR	Digital I/O	Serial audio record clock input/output.
D13	ASYNR	Digital I/O	Serial audio record sync input/output.
A16	ADATR	Digital Output	Serial audio record data output.
A10	SPIB	Digital Input	LO: Enable SPI interface. HI: Enable I ² C interface.
B15	SCL	Digital Input	SPI/I ² C clock input. I ² C interface requires pull-up resistor to DVDDE.
A15	MOSI_SDA	Digital I/O	SPI: Serial data input. I ² C: Serial data I/O. I ² C interface requires pull-up resistor to DVDDE.
B13	MISO_ADDR1	Digital I/O	SPI: Serial data output. I ² C: Bit 1 of slave address select.
D11	CSB_ADDR0	Digital Input	SPI: chip-select. SPI interface is active when LO. I ² C: Bit 0 of slave address select. ADDR1 ADDR0 address LO LO 0x68 LO HI 0x69 HI LO 0x6A HI HI 0x6B
C13	RSTB	Digital Input	Resets device when pulled LO.
A14	TESTEN	Digital Input	For internal use only. Tie LO.
D10	MPP0 (= ADATM)	Digital Output	The ADATM is the serial audio mix data output. The ADATM outputs through the MPP0 pin.
A4, A5, A6, A11, A13, B2, B4, B5, B6, B10, B12, C9, C12, C14, D9, G2, K2, R2, R3, R4, T3, T4	DNC	Do Not Connect	Do not connect anything to these pins.
A7	XTO	Analog Output	27MHz crystal connection.
B7	XTI	Analog Input	27MHz crystal connection or 27MHz/1.0V oscillator input.

Pin Descriptions (Continued)

PIN LOCATION	PIN NAME	TYPE	DESCRIPTION
A2	AVDD_CDR1	Analog Power	1.0V analog power supply for CDR. Place a local 0.1μF ceramic bypass capacitor to the analog ground as close to the pin as possible.
A1	AVSS_CDR1	Analog Ground	Analog ground.
H1	AVDD_CDR2	Analog Power	1.0V analog power supply for CDR. Place a local 0.1μF ceramic bypass capacitor to the analog ground as close to the pin as possible.
H2	AVSS_CDR2	Analog Ground	Analog ground.
J1	AVDD_CDR3	Analog Power	1.0V analog power supply for CDR. Place a local 0.1μF ceramic bypass capacitor to the analog ground as close to the pin as possible.
J2	AVSS_CDR3	Analog Ground	Analog ground.
T2	AVDD_CDR4	Analog Power	1.0V analog power supply for CDR. Place a local 0.1μF ceramic bypass capacitor to the analog ground as close to the pin as possible.
T1	AVSS_CDR4	Analog Ground	Analog ground.
C2, D4, E3, E4, F2, F3, F4, G3, K3, K4, L2, L3, L4, M3, M4, P2	AVSS_EQ	Analog Ground	Analog ground.
D1	AVDD_REG1	Analog Power	1.8V analog power supply for regulator. Place a local 0.1μF ceramic bypass capacitor to the analog ground as close to the pin as possible.
D2	AVSS_REG1	Analog Ground	Analog ground.
E1	AVDD_REG2	Analog Power	1.8V analog power supply for regulator. Place a local 0.1μF ceramic bypass capacitor to the analog ground as close to the pin as possible.
E2	AVSS_REG2	Analog Ground	Analog ground.
M1	AVDD_REG3	Analog Power	1.8V analog power supply for regulator. Place a local 0.1μF ceramic bypass capacitor to the analog ground as close to the pin as possible.
M2	AVSS_REG3	Analog Ground	Analog ground.
N1	AVDD_REG4	Analog Power	1.8V analog power supply for regulator. Place a local 0.1μF ceramic bypass capacitor to the analog ground as close to the pin as possible.
N2	AVSS_REG4	Analog Ground	Analog ground.
H3	AVDD_BG	Analog Power	1.8V analog power supply for band-gap. Place a local 0.1μF ceramic bypass capacitor to the analog ground as close to the pin as possible.
J3	AVSS_BG	Analog Ground	Analog ground.
C5	AVDD_TST1	Analog Power	1.0V analog power supply for test outputs. Place a local 0.1μF ceramic bypass capacitor to the analog ground as close to the pin as possible.
C4	AVSS_TST1	Analog Ground	Analog ground.
P3	AVDD_TST4	Analog Power	1.0V analog power supply for test outputs. Place a local 0.1μF ceramic bypass capacitor to the analog ground as close to the pin as possible.
N3	AVSS_TST4	Analog Ground	Analog ground.
P4	AVDD_DAC	Analog Power	1.8V analog power supply for audio DAC. Place a local 0.1μF ceramic bypass capacitor to the analog ground as close to the pin as possible.
N4	AVSS_DAC	Analog Ground	Analog ground.
T6	AVDD_AFE	Analog Power	1.8V analog power supply for audio AFE (Audio Front-End). Place a local 0.1μF ceramic bypass capacitor to the analog ground as close to the pin as possible.
R6	AVSS_AFE	Analog Ground	Analog ground.
T7	AVDD_FPLL10	Analog Power	1.0V analog power supply for PLL. Place a local 0.1μF ceramic bypass capacitor to the analog ground as close to the pin as possible.
R7	AVSS_FPLL10	Analog Ground	Analog ground.
P7	AVDD_FPLL18	Analog Power	1.8V analog power supply for PLL. Place a local 0.1μF ceramic bypass capacitor to the analog ground as close to the pin as possible.

Pin Descriptions (Continued)

PIN LOCATION	PIN NAME	TYPE	DESCRIPTION
N7	AVSS_FPLL18	Analog Ground	Analog ground.
A9	AVDD_GUARD	Analog Power	1.0V analog power supply guard ring. Place a local 0.1μF ceramic bypass capacitor to the analog ground as close to the pin as possible.
B9	AVSS_GUARD	Analog Ground	Analog ground.
C8	AVDD_MISC10	Analog Power	1.0V analog miscellaneous power supply. Place a local 0.1μF ceramic bypass capacitor to the analog ground as close to the pin as possible.
D8	AVSS_MISC10	Analog Ground	Analog ground.
A8	AVDD_MISC18	Analog Power	1.8V analog miscellaneous power supply. Place a local 0.1μF ceramic bypass capacitor to the analog ground as close to the pin as possible.
B8	AVSS_MISC18	Analog Ground	Analog ground.
C7	AVDD_XTAL	Analog Power	1.0V analog power supply for crystal oscillator. Place a local 0.1μF ceramic bypass capacitor to the analog ground as close to the pin as possible.
D7	AVSS_XTAL	Analog Ground	Analog ground.
C3	AVDD_PLL10	Analog Power	1.0V analog power supply for PLL. Place a local 0.1μF ceramic bypass capacitor to the analog ground as close to the pin as possible.
D3	AVSS_PLL10	Analog Ground	Analog ground.
B3	AVDD_PLL18	Analog Power	1.8V analog power supply for PLL. Place a local 0.1μF ceramic bypass capacitor to the analog ground as close to the pin as possible.
A3	AVSS_PLL18	Analog Ground	Analog ground.
C6, D5, D6, E5, E6, F5, G4, G5, H4, H5, H6, J4, J5, J6, K5, K6, L5, M5	AVSS_ESD	Analog Ground	Analog ground.
E7, E8, E9, E10, E11, F6, F7, G6, G7, J12, K12, L12, M12	DVDDE	Digital Power	3.3V digital power supply for I/O. Place a local 0.1μF ceramic bypass capacitor to the digital ground as close to the pin as possible.
E12, F12, G12, H12, K7, L6, L7, M6, M7, M8, M9, M10, M11	DVDDI	Digital Power	1.0V digital power supply for core. Place a local 0.1μF ceramic bypass capacitor to the digital ground as close to the pin as possible.
F8, F9, F10, F11, G8, G9, G10, G11, H7, H8, H9, H10, H11, J7, J8, J9, J10, J11, K8, K9, K10, K11, L8, L9, L10, L11	DVSS	Digital Ground	Digital ground.

Ordering Information

PART NUMBER <small>(Notes 1, 2)</small>	PART MARKING	TEMP. RANGE (°C)	PACKAGE (RoHS Compliant)	PKG. DWG. #
TW6874-BB1-CR	TW6874 BB1-CR	0 to +70	256 ball LFBGA (13.5mmx13.5mm)	V256.13.5x13.5
TW6874-BB1-CR-EVALZ	Evaluation Board			

NOTES:

- These Intersil Pb-free WLCSP and BGA packaged products employ special Pb-free material sets; molding compounds/die attach materials and SnAgCuNi- e8 solder ball terminals, which are RoHS compliant and compatible with both SnPb and Pb-free soldering operations. Intersil Pb-free WLCSP and BGA packaged products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.
- For Moisture Sensitivity Level (MSL), please see product information page for [TW6874](#). For more information on MSL please see tech brief [TB363](#).

Absolute Maximum Ratings

Supply Pins

AVDD_CDR1 to AVSS_CDR1	+1.2V
AVDD_CDR2 to AVSS_CDR2	+1.2V
AVDD_CDR3 to AVSS_CDR3	+1.2V
AVDD_CDR4 to AVSS_CDR4	+1.2V
AVDD_FPLL10 to AVSS_FPLL10	+1.2V
AVDD_PLL10 to AVSS_PLL10	+1.2V
AVDD_XTAL to AVSS_XTAL	+1.2V
AVDD_MISC10 to AVSS_MISC10	+1.2V
AVDD_GUARD to AVSS_GUARD	+1.2V
AVDD_TST1 to AVSS_TST1	+1.2V
AVDD_TST4 to AVSS_TST4	+1.2V
AVDD_BG to AVSS_BG	+2.5V
AVDD_REG1 to AVSS_REG1	+2.5V
AVDD_REG2 to AVSS_REG2	+2.5V
AVDD_REG3 to AVSS_REG3	+2.5V
AVDD_REG4 to AVSS_REG4	+2.5V
AVDD_AFE to AVSS_AFE	+2.5V
AVDD_DAC to AVSS_DAC	+2.5V
AVDD_FPLL18 to AVSS_FPLL18	+2.5V
AVDD_PLL18 to AVSS_PLL18	+2.5V
AVDD_MISC18 to AVSS_MISC18	+2.5V
DVDDI to DVSS	+1.2V
DVDDE to DVSS	+4.0V

Other Pins

Analog Audio Input Voltage	AVSS_AFE V to AVDD_AFE V
Analog Audio Output Voltage	AVSS_DAC V to AVDD_DAC V
Voltage on any Digital Pin	DVSS V to DVDDE V

ESD Ratings

Human Body Model (JS-001-2010)	2kV
Charged Device Model (JESD22-C101E)	750V

CAUTION: Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions may adversely impact product reliability and result in failures not covered by warranty.

NOTES:

- θ_{JA} is measured in free air with the component mounted on a high effective thermal conductivity test board with “direct attach” features. See Tech Brief [TB379](#).
- For θ_{JC} , the “case temp” location is taken at the package top center.

Thermal Information

Thermal Resistance (Typical)	θ_{JA} (°C/W)	θ_{JC} (°C/W)
LFPGA Package (Notes 3, 4)	22.7	7.9
Power Dissipation	See Electrical Specifications page 14	
Maximum Die Temperature	+125°C	
Storage Temperature	-65°C to +150°C	
Pb-free Reflow Profile	see TB493	

Recommended Operating Conditions

Ambient Operating Temperature	0°C to +70°C
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TW6874

Electrical Specifications AVDD_1V0 = AVDD_CDR1 = AVDD_CDR2 = AVDD_CDR3 = AVDD_CDR4 = AVDD_PLL10 = AVDD_FPLL10 = AVDD_XTAL = AVDD_MISC10 = AVDD_GUARD = AVDD_TST1 = AVDD_TST4 = 1.0V, AVDD_1V8 = AVDD_BG = AVDD_REG1 = AVDD_REG2 = AVDD_REG3 = AVDD_REG4 = AVDD_AFE = AVDD_PLL18 = AVDD_FPLL18 = AVDD_MISC18 = AVDD_DAC = 1.8V, DVDD_1V0 = DVDDI = 1.0V, DVDD_3V3 = DVDE = 3.3V, T_A = +25°C, unless otherwise specified.

PARAMETER	DESCRIPTION	TEST CONDITIONS	MIN (Note 5)	TYP	MAX (Note 5)	UNITS
POWER SUPPLY VOLTAGE						
AVDD_1V0	Analog 1.0V Supply Voltage		0.95	1.0	1.05	V
AVDD_1V8	Analog 1.8V Supply Voltage		1.7	1.8	1.9	V
DVDD_1V0	Digital 1.0V Core Supply Voltage		0.95	1.0	1.05	V
DVDD_3V3	Digital 3.3V IO Supply Voltage		3.0	3.3	3.6	V
POWER DISSIPATION						
I_AVDD_1V0	Analog 1.0V Supply Current			250		mA
I_AVDD_1V8	Analog 1.8V Supply Current			450		mA
I_DVDD_1V0	Digital 1.0V Core Supply Current			400		mA
I_DVDD_3V3	Digital 3.3V IO Supply Current	16-bit		85		mA
		8-bit		215		mA
P _{TOTAL}	Total Power	16-bit		1740		mW
		8-bit		2170		mW
PARALLEL VIDEO OUTPUT (Note 8)						
f _{CLK}	Pixel Clock Frequency	SD 270Mbps uncompressed serial data input to 8-bit parallel output format. Figure 5		27		MHz
		1. HD 1.485Gbps uncompressed serial data input to 16-bit parallel output format. Figure 6 . 2. HD 270Mbps compressed serial data input to 16-bit parallel output format. Figure 6 .		74.25		MHz
		1. HD 1.485Gbps uncompressed serial data input to 8-bit parallel output format. Figure 7 . 2. HD 270Mbps compressed serial data input to 8-bit parallel output format. Figure 7 .		148.5		MHz
DCYC	Pixel Clock Duty Cycle		45		55	%
t _S	Setup Time (1a in Figure 4)	From V _{Dn} transition to rising edge of CLK _{Nn}	3			ns
t _H	Hold Time (1b in Figure 4)	From rising edge of CLK _{Nn} to V _{Dn} transition	0.5			ns
SDI ANALOG INPUTS						
SDR	Serial Data Rate		0.27		1.5	Gbps
VIS	Serial Data Input Swing				880	mV
CL59	Achievable Cable Length RG59 (Note 6)	1.485Gbps		150		m
		270Mbps (SD or VC-2)		300		m
CL3C2V	Achievable Cable Length 3C-2V (Note 6)	1.485Gbps		70		m
		270Mbps (SD or VC-2)		120		m
DIGITAL INPUTS						
V _{IH}	Input High Voltage		2.0		DVDD_3V3	V
V _{IL}	Input Low Voltage		0		0.8	V
I _L	Input Leakage Current		-10	0	+10	μA
C _{IN}	Input Capacitance	f = 1MHz, V _{IN} 2.4V		2		pF

TW6874

Electrical Specifications AVDD_1V0 = AVDD_CDR1 = AVDD_CDR2 = AVDD_CDR3 = AVDD_CDR4 = AVDD_PLL10 = AVDD_FPLL10 = AVDD_XTAL = AVDD_MISC10 = AVDD_GUARD = AVDD_TST1 = AVDD_TST4 = 1.0V, AVDD_1V8 = AVDD_BG = AVDD_REG1 = AVDD_REG2 = AVDD_REG3 = AVDD_REG4 = AVDD_AFE = AVDD_PLL18 = AVDD_FPLL18 = AVDD_MISC18 = AVDD_DAC = 1.8V, DVDD_1V0 = DVDDI = 1.0V, DVDD_3V3 = DVDDE = 3.3V, T_A = +25°C, unless otherwise specified. (Continued)

PARAMETER	DESCRIPTION	TEST CONDITIONS	MIN (Note 5)	TYP	MAX (Note 5)	UNITS
DIGITAL OUTPUTS						
VOH	Output High Voltage	IO = -2mA	2.4			V
VOL	Output Low Voltage	IO = +2mA			0.4	V
I _{OZ}	Tri-State Current				10	μA
CRYSTAL						
f _{XTAL}	Nominal Frequency (Fundamental)			27		MHz
DEV _{XTAL}	Deviation (Note 7)				±30	ppm
CL	Load Capacitance			22		pF
RS	Series Resistor (ESR)			50		Ω
ANALOG AUDIO INPUT						
V _I FULL	Full Scale Input Voltage Range (Note 9)		0.13		1.76	V _{P,P}
	Interchannel Isolation (Note 10)			90		dB
ANALOG AUDIO OUTPUT						
V _O FULL	Full Scale Output Voltage (Note 11)			1.4		V _{P,P}
	Total Harmonic Distortion (THD)			51		dB
	Signal to Noise Ratio (SNR)			64		dB
DIGITAL AUDIO						
t _A _pd	ASYNR, ADATR, ADATM Propagation Delay		1.0		4	ns
t _A _hw	ACLKP High Pulse Duration		27			ns
t _A _lw	ACLKP Low Pulse Duration (Note 12)		54			ns
t _A _su	ASYNP, ADATP Setup Time (Note 12)		26			ns
t _A _h	ASYNP, ADATP Hold Time		25			ns
I²C SERIAL CONFIGURATION INTERFACE (Figure 25)						
f _{SCL}	SCL Clock Frequency				400	kHz
t _{SU:STA}	Set-up Time for a START Condition		370			ns
t _{HD:STA}	Hold Time for a START Condition		74			ns
t _{SU:STO}	Set-up Time for a STOP Condition		370			ns
t _{BUF}	Bus Free Time between a STOP and START Condition		740			ns
t _{SU:DAT}	Data Set-up Time		74			ns
t _{HD:DAT}	Data Hold Time		50		900	ns
t _r	Rise Time of SDA and SCL				300	ns
t _f	Fall Time of SDA and SCL				300	ns
CBUS	Capacitive Load for each Bus Line				400	pF

Electrical Specifications AVDD_1V0 = AVDD_CDR1 = AVDD_CDR2 = AVDD_CDR3 = AVDD_CDR4 = AVDD_PLL10 = AVDD_FPLL10 = AVDD_XTAL = AVDD_MISC10 = AVDD_GUARD = AVDD_TST1 = AVDD_TST4 = 1.0V, AVDD_1V8 = AVDD_BG = AVDD_REG1 = AVDD_REG2 = AVDD_REG3 = AVDD_REG4 = AVDD_AFE = AVDD_PLL18 = AVDD_FPLL18 = AVDD_MISC18 = AVDD_DAC = 1.8V, DVDD_1V0 = DVDDI = 1.0V, DVDD_3V3 = DVDDDE = 3.3V, T_A = +25°C, unless otherwise specified. (Continued)

PARAMETER	DESCRIPTION	TEST CONDITIONS	MIN (Note 5)	TYP	MAX (Note 5)	UNITS
SPI SERIAL CONFIGURATION INTERFACE (Figures 31 and 32)						
f _{SER}	SCL Maximum Operating Frequency				10	MHz
DC _{SCL}	SCL Duty Cycle		40	50	60	%
t _{EL}	CSB High Time		20			ns
t _{ERSR}	CSB Falling Edge to the First SCL Rising Edge		10			ns
t _{DS}	MOSI Set-up Time		5			ns
t _{DH}	MOSI Hold Time		5			ns
t _{SREF}	Last SCL Rising Edge to CSB Rising Edge		10			ns
t _{WRITE}	Write Wait Period		3*t _{scl}			ns
t _{READ}	Read Wait Period		9*t _{scl}			ns

NOTES:

5. Compliance to datasheet limits is assured by one or more methods: production test, characterization and/or design.
6. Performance is cable dependent. Bare copper conductor cable offers better performance than copper clad steel/aluminum conductor cable.
7. Crystal deviation is based on normal operating condition.
8. CLK_n timing is affected by the CLK_DEL register.
9. Tested at input gain of 0dB. f_{IN} = 1kHz.
10. Tested at input gain of 0dB. f_S = 8kHz and 16kHz.
11. Tested at output gain of 0dB. F_{OUT} = 1kHz.
12. t_{A_lw} and t_{A_su} Min values are for f_S = 48kHz mode only. If f_S < 48kHz, the Min values are larger. High period of ACLKR/ACLKP is one 36MHz clock period.

SDI Video Inputs

The TW6874 receives serial digital (SDI) video data on four independent channels. Each channel consists of an equalizer (EQ), a Clock and Data Recovery (CDR) unit, SDI descrambler/deframer, SDI speed/format auto-detection and VC2 decompression.

SDI Video Formats

The supported SDI video formats include:

- 270Mbps (SMPTE 259M Level C)
 - 525i/625i 50, 59.94 fields/s
 - VC-2 compressed 720p 50, 59.94 frames/s
 - VC-2 compressed 1080p 25, 29.97 frames/s
 - VC-2 compressed 1080i 50, 59.94 fields/s
- 1.485Gbps (SMPTE ST 292)
 - 720p 25, 30 frames/s
 - 720p 50, 60 frames/s
 - 1080PsF 25, 30 frames/s
 - 1080p 24, 25, 30 frames/s
 - 1080i 50, 60 fields/s
- 1.485/1.001Gbps (SMPTE ST 292)
 - 720p 59.94 frames/s
 - 1080PsF 29.97 frames/s
 - 1080p 23.976, 29.97 frames/s
 - 1080i 59.94 fields/s

Any of the supported video formats can be driven into any of the four SDI inputs without limitation. The video streams are received in 10-bit YCbCr 4:2:2 sampled format. The deserialized video outputs are truncated into 8-bit YCbCr 4:2:2 sampled format.

Adaptive Equalization

The TW6874 adaptive equalizers (EQ) function to compensate for link losses of various frequency components up to 1.5Gbps. The EQ compensates for nonlinear cable attenuation such that overall end-to-end frequency response is flat.

Clock Data Recovery/Descrambler

The SDI signal embeds its clock in the serialized bit stream. To recover the serial bit data, the embedded clock is recovered from the transition edges of the data stream. The data bit sequence is derived by using the recovered clock to latch the bits from the EQ output signal. The TW6874 clock data recovery module (CDR) recovers the low jitter embedded clock by using a high performance PLL to track the incoming data stream.

To ensure that enough data transitions occur in any video content, the SDI standard employs a scrambling circuit in the transmitter. At the receiver side, after the CDR function is performed, a descrambler circuit is then used to convert the scrambled bit sequences back into the original video data content.

SDI Auto Detection

The link speed mode of SDI is automatically detected by the hardware auto detection module. When the TW6874 is powered up initially or when the link mode has changed, the hardware switches among HD/SD modes until the CDR locks on to the link data.

Once the PLL has locked to the data stream, the hardware detects valid data from the link. The SDI_MODE_LOCKED bit is set in register 0x000/2/4/6 when the TW6874 has locked to a valid bit rate and received valid SDI data. The detected mode is available from SDI_MODE in the same register.

After the link speed mode is locked, the hardware further detects the video formats such as: video resolution, frame rate and scan mode. When a valid format is detected, the T_LOCKED flag is set in register 0x000/2/4/6 and the detected video format is shown in T_SCAN, T_RATE and T_FAMILY status registers at 0x000~0x007.

VC-2 (Dirac) Decompression

Compressed VC-2 serial data streams are received at SD-SDI (270Mbps) data rates. The data formats supported are according to SMPTE 259M standard and are as follows:

- Compressed 720p 50, 59.94 frames/s
- Compressed 1080p 25, 29.97 frames/s
- Compressed 1080i 50, 59.94 fields/s

The generated pixel clock is 74.25MHz in BT.1120 16-bit mode or 148.5MHz in BT.1120 8-bit mode.

Cable Reach

The TW6874 is designed to work with various types of 75Ω coaxial cable: e.g., RG6, RG59, or 3C-2V. Each of these cable types have various core and shielding variations. Cable reach performance is a function of the cable configuration. To achieve the best performance for any given type of cable, the PCB layout guidelines [page 88](#) should be adhered to closely. It is recommended to emulate the reference layout.

Video Output Format

The TW6874 receives serial data and converts it to the equivalent parallel ITU-R BT.656/BT.1120 format. In BT.656/BT.1120 format, timing reference signals (TRS, consisting of SAV and EAV codes) are inserted into the data stream to indicate the active video time. The output timing is illustrated in [Figure 3](#).

Video Output Port Mapping

Each video output port maps only from its associated SDI input port. For example, SDI1 maps to VD1; SDI2 maps to VD2, etc. The output data format is: BT.656 for SD; BT.1120 for HD in either 8-bit or 16-bit mode.

For SD formats, the same BT.656 video data is output on lower byte (VDn[7:0]) of the 16-bit port as shown in [Figure 5](#).

For HD formats, the output data can be either BT.1120 16-bit, or 8-bit mode with the pixel clock running at twice the speed.

In BT.1120 mode, Y is output on the lower byte (bits 7:0) and C is output on the upper byte (bits 15:8). In 8 bit mode, the Y/C data is output on both bytes of the video port as shown in [Figure 7](#).

[Figure 4](#) shows the timing relationship for the output clock and data for single and double clock rate operation. [Figures 5 to 7](#) show the allowed data output formats.

In [Figures 4 to 7](#), n = 1 to 4.

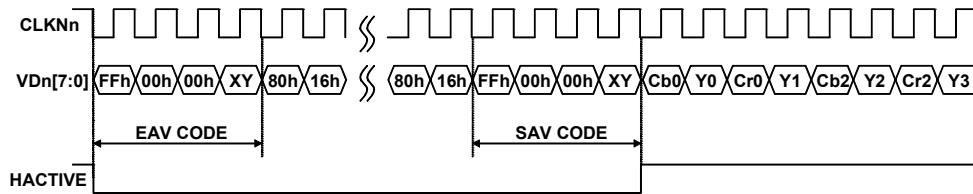


FIGURE 3. BT.656/BT.1120 LIKE FORMAT

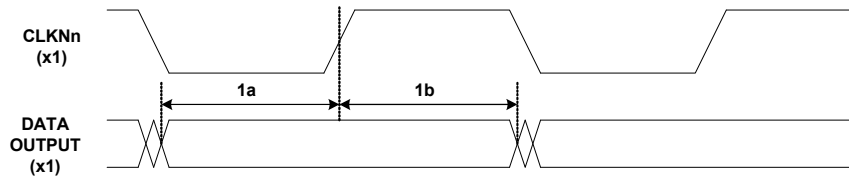


FIGURE 4. CLKNn TO VD[15:0] TIMING

SD BT.656 Output Format

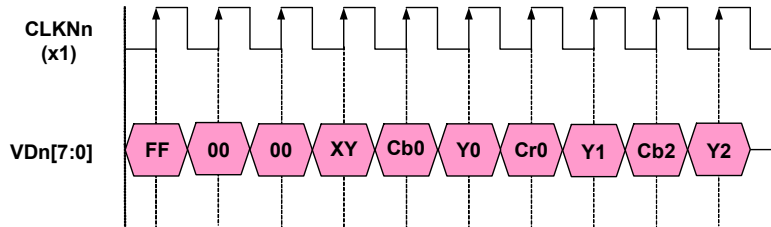


FIGURE 5. ONE SD CHANNEL BT.656 FORMAT, CLKNn AT 27MHz

HD BT.1120 16-Bit or 8-Bit Output Formats

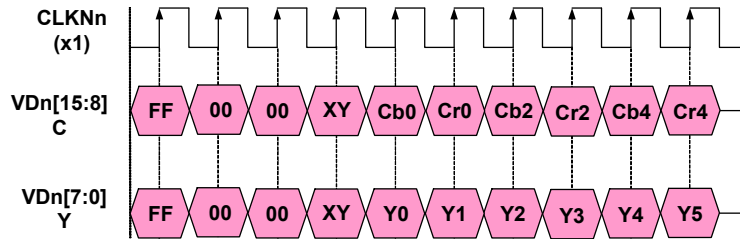


FIGURE 6. ONE HD CHANNEL BT.1120 16-BIT FORMAT, CLK_{Nn} AT 74.25MHz (HD)

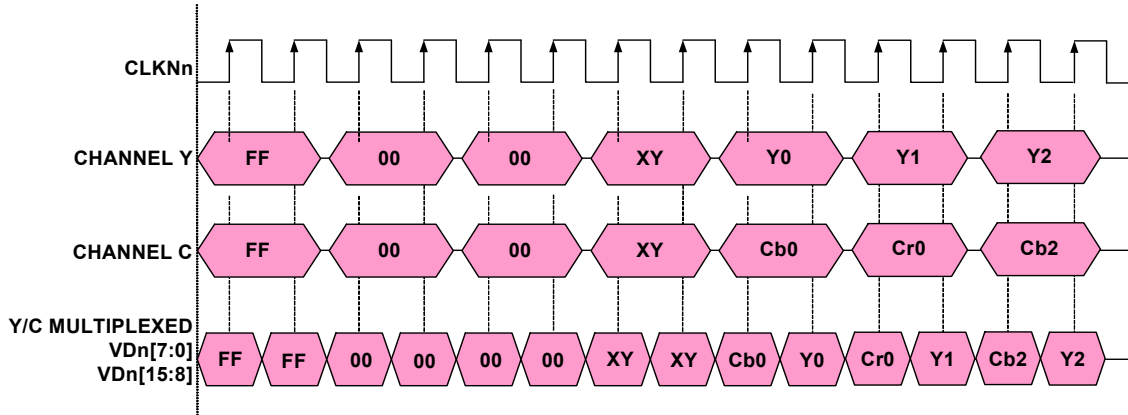


FIGURE 7. ONE HD CHANNEL BT.1120 8-BIT MODE FORMAT, CLK_{Nn} AT 148.5MHz

Audio Interface

Audio CODEC

The audio CODEC in the TW6874 is composed of five Analog-to-Digital Converters (ADC), one Digital-to-Analog Converter (DAC), audio mixer and digital serial audio interface as shown in Figure 8. The TW6874 can receive 5 analog audio signals, 4 SDI ancillary audio signals and 1 multi-channel digital serial audio stream. It can produce 1 mixing analog audio signal and 2 digital serial audio streams.

The analog audio input signal gain for the AIN1/2/3/4/5 pins can be adjusted respectively by internal programmable gain amplifiers that are defined via the AIGAIN1/2/3/4/5 registers before being sampled by the ADCs. If the SDI stream has ancillary audio embedded, these can be used in lieu of AIN1/2/3/4. The ACLKP, ASYNP and ADATP pins from the I2S decoder block are used to receive digital serial audio input data for playback. To record audio data, the I2S encoder block

provides the digital serial audio output via the ACLKR, ASYNR and ADATR pins. The AOUT pin sends analog audio data received from the audio DAC. The output level can be controlled by a programmable gain amplifier via the DAC_GAIN register.

The TW6874 can mix all the audio inputs including analog audio and digital audio according to the predefined mixing ratio for each audio via the MIX_RATIO1/2/3/4/5/PB registers. This mixing audio output can be provided through the analog and digital interfaces. The embedded audio DAC supports the analog mixing audio output. The ADATM pin supports the digital mixing audio output and its digital serial audio timings are provided through the ACLKR and ASYNR pins that are shared with the digital serial audio record timing pins.

The main purpose of the AIN5 pin is to make the standard I2S digital audio output for AIN5 data available on the ADATM pin for audio back channel applications. Usually, AIN1/2/3/4 audio data are output to the CODEC on the ADATR pin.

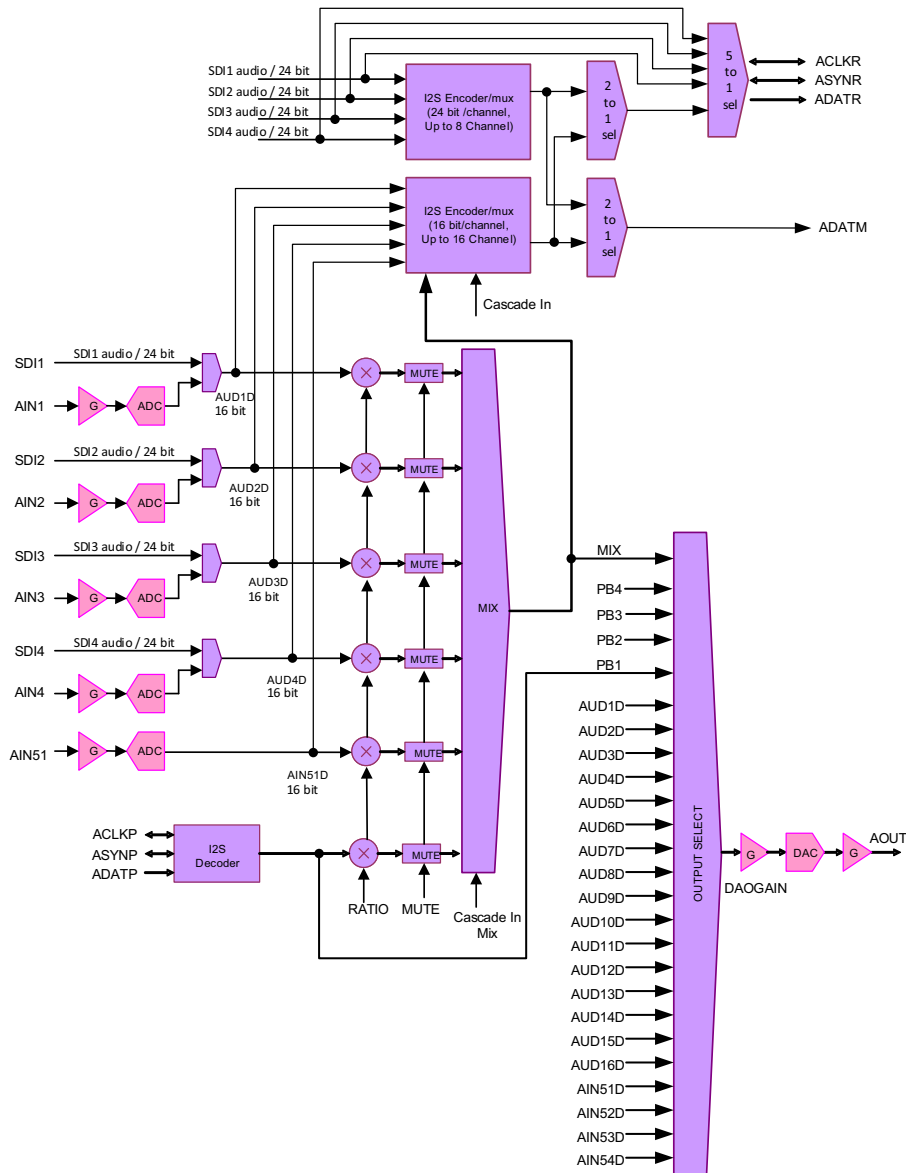


FIGURE 8. AUDIO CODEC BLOCK DIAGRAM

SDI Ancillary Audio

Embedded SDI ancillary audio is formed of 4 groups of 4 channels. Each audio sample is 24 bits wide, depending on whether it is embedded in SD/VC2 or HD. One of these channels can be selected from each SDI input and sent to the TW6874's audio processor. If an SDI audio channel is selected, the respective analog audio input is not used.

SDI ancillary audio uses 48kHz sampling frequencies.

The TW6874 can truncate SDI ancillary audio to 16 bits in order to allow mixing with the analog audio data from channels where SDI audio is not used.

Serial Audio Interface

There are three kinds of digital serial audio interfaces in the TW6874. The first is a multichannel recording output, the second is a mixing output and the third is a playback input. These three digital serial audio interfaces follow a standard I2S interface as shown in Figure 9. The I2S MUX can output audio channels from each of the SDI channel, multiplexed 24-bit audio channels from 4 SDI channels, or multiplexed 16-bit 16 audio channels from SDI, ADC and I2S input.

PLAYBACK INPUT

The serial interface using the ACLKP, ASYNP and ADATP pins accepts the digital serial audio data for playback. The ACLKP and ASYNP pins can be operated in master or slave mode. For master

mode, these pins work as outputs and generate the standard audio clock and synchronizing signals. For slave mode, these pins are inputs and accept the standard audio clock and synchronizing signals. The ADATP pin is always an input regardless of the operating mode. One channel of audio data (from the left or right channel) should be selected for playback audio by the PB_LRSEL.

RECORD OUTPUT

To record audio data, the TW6874 provides the digital serial audio data through the ACLKR, ASYNR and ADATR pins. The sampling frequency comes from the $256 \cdot f_s$, $320 \cdot f_s$ or $384 \cdot f_s$ audio system clock setting. Even though the standard I2S and DSP format can have only two audio data on left and right channel, the TW6874 can provide an extended I2S and DSP format, which can have 16 channel audio data through the ADATR pin. The R_MULTCH defines the number of audio channels to be recorded by the ADATR pin. ASYNR's frequency is always at the sampling frequency (f_s). Thus, one ASYNR period is always equal to $256 \cdot \text{ACLKR}$ periods when AIN5MD = 0. Figure 10 shows the digital serial audio data organization for multichannel audio.

The ACLKR pin can be operated in master or slave mode. For master mode, this pin works as an output and generates the standard audio clock. For slave mode, this pin is an input and accepts the standard audio clock. The ASYNR pin can be operated as an input or output regardless of the operating mode. The ADATR pin is always an output.

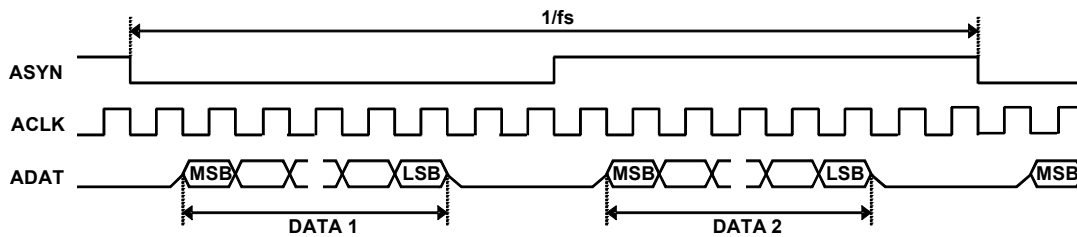


FIGURE 9A. I2S FORMAT

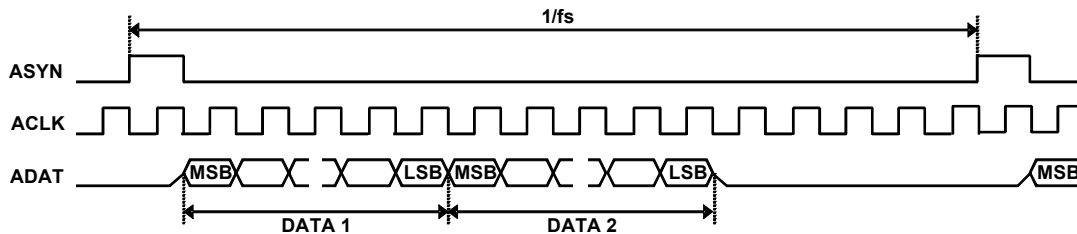


FIGURE 9B. DSP FORMAT

FIGURE 9. SERIAL AUDIO INTERFACE FORMAT

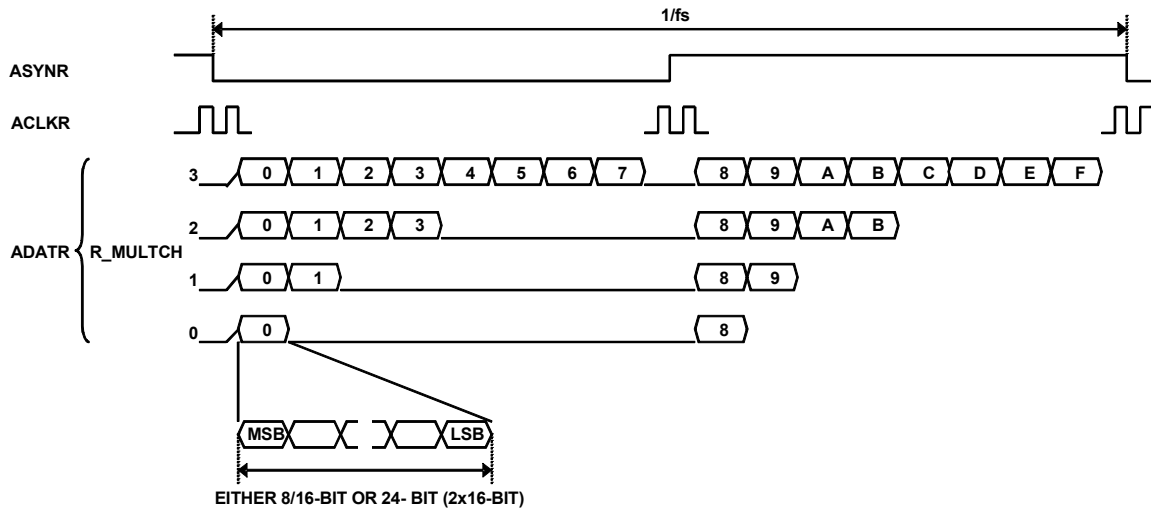


FIGURE 10A. I2S FORMAT

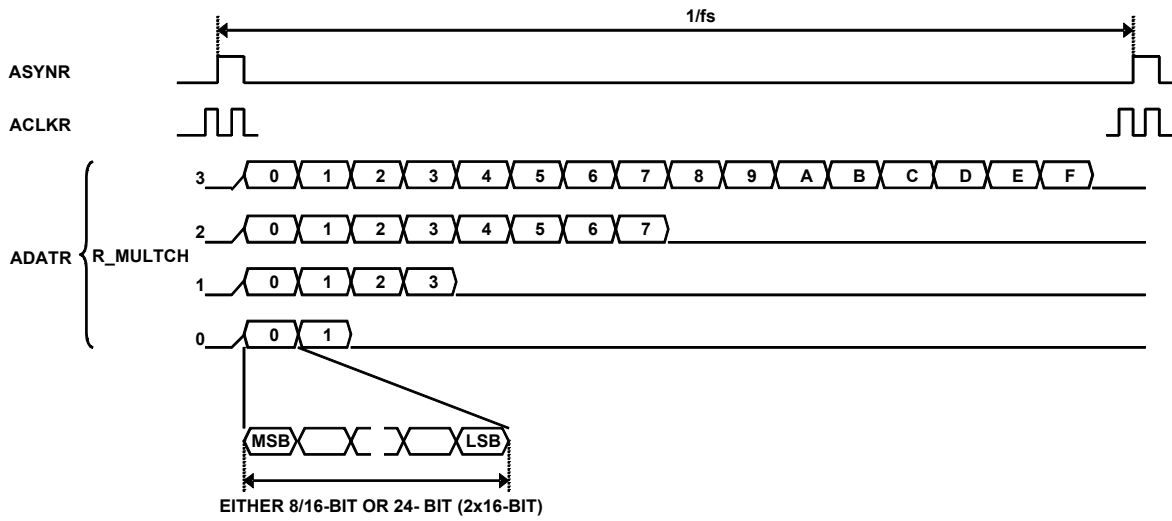


FIGURE 10B. DSP FORMAT

FIGURE 10. MULTICHANNEL AUDIO RECORD FORMAT

TABLE 1. MULTICHANNEL AUDIO RECORD SEQUENCE (I2S)

R_MULTCH	PIN	LEFT CHANNEL								RIGHT CHANNEL							
0	ADATR	0								8							
	ADATM	F								7							
1	ADATR	0	1							8	9						
	ADATM	F	E							7	6						
2	ADATR	0	1	2	3					8	9	A	B				
	ADATM	F	E	D	C					7	6	5	4				
3	ADATR	0	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F
	ADATM	F	E	D	C	B	A	9	8	7	6	5	4	3	2	1	0

TABLE 2. MULTICHANNEL AUDIO RECORD SEQUENCE (DSP)

R_MULTCH	PIN	LEFT/RIGHT CHANNEL															
0	ADATR	0	1														
	ADATM	F	E														
1	ADATR	0	1	2	3												
	ADATM	F	E	D	C												
2	ADATR	0	1	2	3	4	5	6	7								
	ADATM	F	E	D	C	B	A	9	8								
3	ADATR	0	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F
	ADATM	F	E	D	C	B	A	9	8	7	6	5	4	3	2	1	0

Tables 1 (I2S) and 2 (DSP) show the sequence of audio data to be recorded for each mode of the R_MULTCH register. The sequences of 0 ~ F do not mean actual audio channel numbers but represent sequence only. The actual audio channel should be assigned to sequence 0 ~ F by the R_SEQ0 ~ R_SEQF registers. The audio sequence of ADATM is also shown in these two tables. The ADATM pin is configured for record via the R_ADATM register.

MIX OUTPUT

The digital serial audio data on the ADATM has two different audio data: mixing audio and playback audio. The mixing digital serial audio data is the same as the analog mixing output. The sampling frequency, bit width and number of audio channels for the ADATM pin are same as the ADATR pin because the ACLKR and ASYNR pins are shared with the ADATR and ADATM pins.

Multidevice Cascading

The TW6874 can output 16 channel 8-bit/16-bit audio data on the ACLKR/ASYNR/ADATR outputs simultaneously. Therefore, up to 4 devices can be connected in most multidevice application cases.

Since each stage device can accept 4+1 analog audio signals or 4 SDI audio signals, four cascaded devices will be a 16-channel 16-bit audio controller by default {AFS384, AIN5MD} = 00. The first stage device provides 16-channel 8-bit/16-bit digital serial audio data for record. Even though the first stage device has only one digital serial audio data pin ADATR for record, the TW6874 can generate 16 channel data simultaneously using the

multichannel method. This first stage device can also output 16 channel mixing audio data of the digital serial audio data, SDI ancillary audio data (16-bit) and analog audio signal. The first stage device accepts the digital serial audio data for playback. The digital playback data can be converted to analog signal by the DAC in the first stage.

Several master/slave mode configurations are available. Figure 11 is the most recommended and demanded system with Clock Master mode (ACLKRMASMASTER = 1). Figure 12 is the most recommended system with Clock Slave/Sync Slave mode (ACLKRMASMASTER = 0, ASYNROEN = 1). Other system combinations are also available dependent upon the application.

In Figures 11 and 12, Mix1-16-51-54/Pb1 means mix output of AIN1-16, AIN51-54 and Playback1. AIN1-16-51-54/Pb1 means one selected audio output from AIN1-16-51-54/Pb1.

If any one of the TW6874s use {AFS384, AIN5MD} = 01 or {AFS384, AIN5MD} = 10, all other cascaded TW6874s must be set up with the same {AFS384 AIN5MD} mode.

In multidevice audio operation mode, the same oscillator clock source needs to be connected to each TW6874 XTI pin.

TW6874

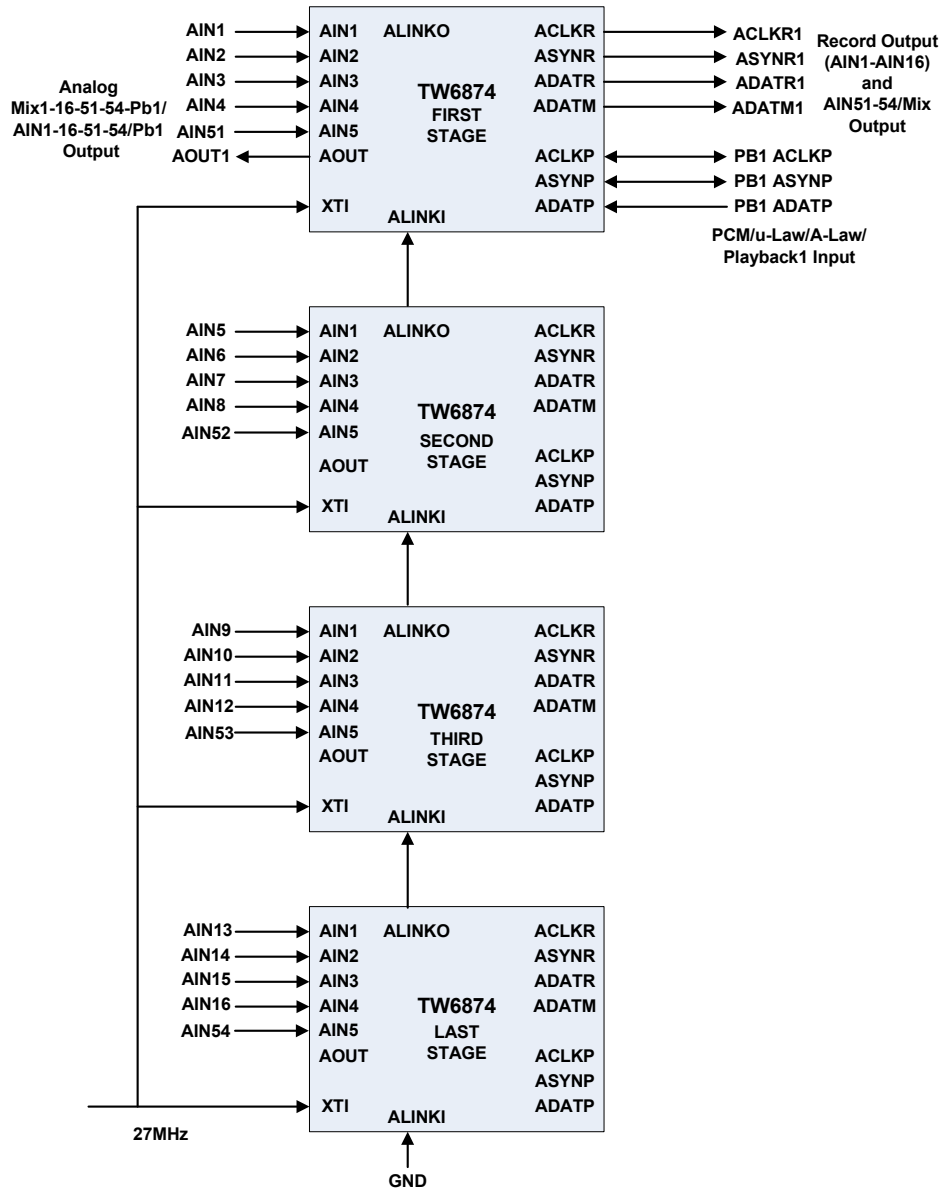


FIGURE 11. RECOMMENDED CLOCK MASTER CASCADE MODE CONFIGURATION

TW6874

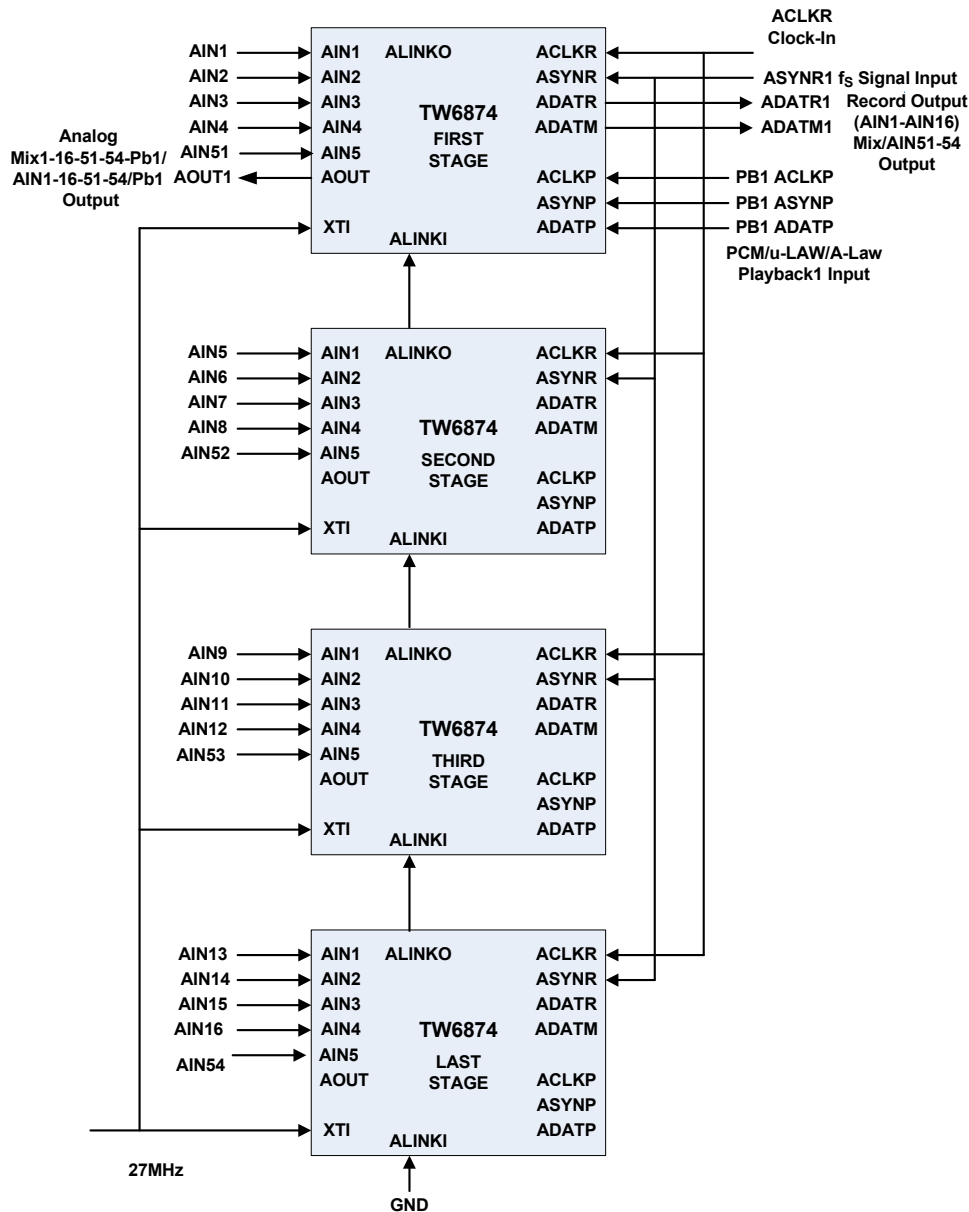


FIGURE 12. RECOMMENDED CLOCK SLAVE/SYNC SLAVE MODE CONFIGURATION

Audio Clock Master/Slave Mode

The TW6874 has two types of audio clock modes. If the ACLKRMAS_{TER} register is set to 1, analog audio is sampled by the audio clock internally generated by the ACKG (Audio Clock Generator). In this master mode, ACLKR/ASYNR pins are outputs. The ASYNROEN register for ASYNR pin should be set to 0 (output enable mode). If the ACLKRMAS_{TER} register is set to 0, analog audio is sampled by the audio clock on the ACLKR pin input. A $256 \cdot f_S$, $320 \cdot f_S$ or $384 \cdot f_S$ audio clock should be connected to the ACLKR pin from an external master clock source in this slave mode. The ASYNR pin can be either input or output in slave mode. ASYNR's frequency should match the audio sample frequency (f_S) in both master and slave mode. The AIN5MD and AFS384 registers configure the analog audio sample mode per Table 3.

TABLE 3.

REGISTER		f_S MODE
AIN5MD	AFS384	
0	0	$256 \cdot f_S$
1	0	$320 \cdot f_S$
0	1	$384 \cdot f_S$

ACLKR Slave Mode Data Output Timing

The TW6874 always outputs ASYNR/ADATR/ADATM on the falling edge of ACLKR. A new ADATR/ADATM word (or multiple words if using multichannel mode) is output upon each toggle of ASYNR. If ASYNR is an input, it is sampled on the falling edge of ACLKR.